

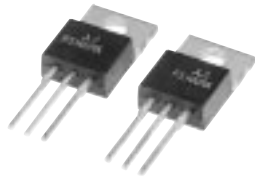
PRELIMINARY
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 Some parametric limits are subject to change.

MITSUBISHI Nch POWER MOSFET

FS10UMA-5A

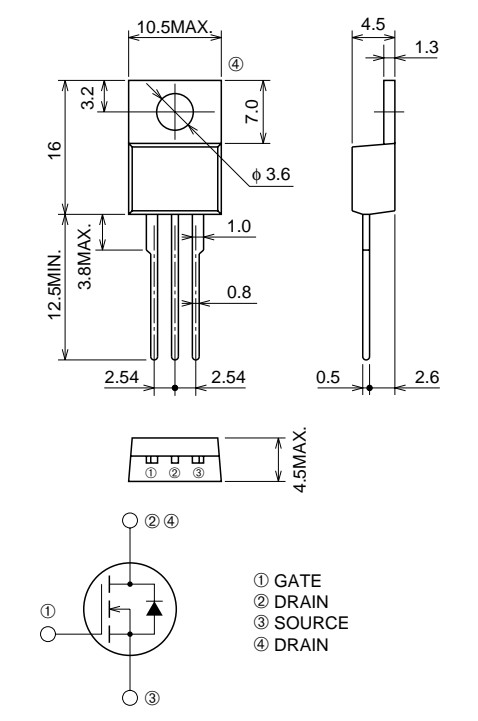
HIGH-SPEED SWITCHING USE

FS10UMA-5A



- 10V DRIVE
- V_{DSS} 250V
- r_{DS (ON)} (MAX) 0.52Ω
- I_D 10A

OUTLINE DRAWING Dimensions in mm



① GATE
 ② DRAIN
 ③ SOURCE
 ④ DRAIN

TO-220

APPLICATION

Cs Switch for CRT Display monitor

MAXIMUM RATINGS (T_c = 25°C)

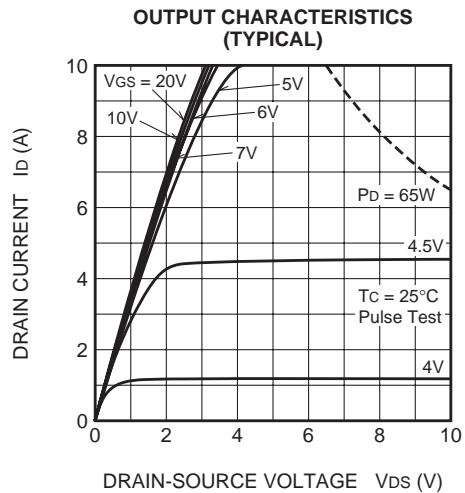
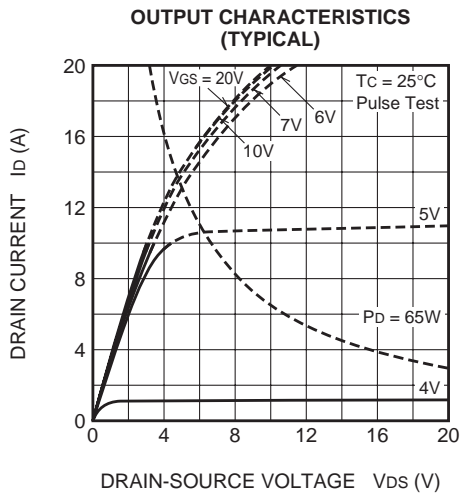
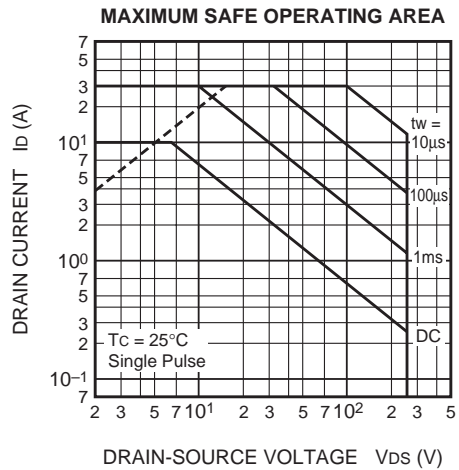
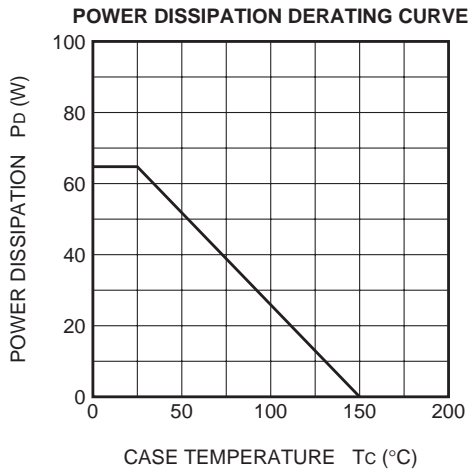
Symbol	Parameter	Conditions	Ratings	Unit
V _{DSS}	Drain-source voltage	V _{GS} = 0V	250	V
V _{GSS}	Gate-source voltage	V _{DS} = 0V	±20	V
I _D	Drain current		10	A
I _{DM}	Drain current (Pulsed)		30	A
I _{DA}	Avalanche current (Pulsed)	L = 200μH	10	A
P _D	Maximum power dissipation		65	W
T _{ch}	Channel temperature		-55 ~ +150	°C
T _{stg}	Storage temperature		-55 ~ +150	°C
—	Weight	Typical value	2.0	g

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ELECTRICAL CHARACTERISTICS (Tch = 25°C)

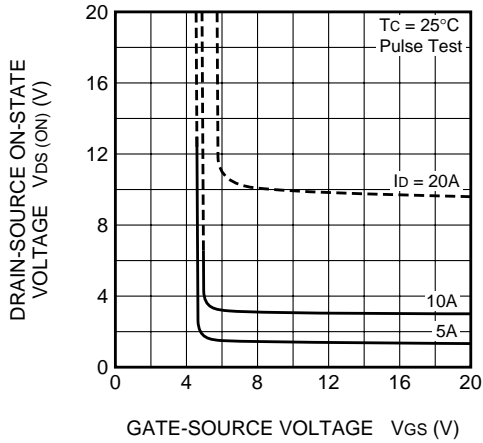
Symbol	Parameter	Test conditions	Limits			Unit
			Min.	Typ.	Max.	
V(BR)DSS	Drain-source breakdown voltage	ID = 1mA, VGS = 0V	250	—	—	V
IGSS	Gate-source leakage current	VGS = ±20V, VDS = 0V	—	—	±0.1	μA
IDSS	Drain-source leakage current	VDS = 250V, VGS = 0V	—	—	1	mA
VGS(th)	Gate-source threshold voltage	ID = 1mA, VDS = 10V	2.0	3.0	4.0	V
rDS(ON)	Drain-source on-state resistance	ID = 5A, VGS = 10V	—	0.40	0.52	Ω
VDS(ON)	Drain-source on-state voltage	ID = 5A, VGS = 10V	—	2.00	2.60	V
yfs	Forward transfer admittance	ID = 5A, VDS = 10V	—	9.0	—	S
Ciss	Input capacitance	VDS = 25V, VGS = 0V, f = 1MHz	—	950	—	pF
Coss	Output capacitance		—	90	—	pF
Crss	Reverse transfer capacitance		—	25	—	pF
td(on)	Turn-on delay time	VDD = 150V, ID = 5A, VGS = 10V, RGEN = RGS = 50Ω	—	20	—	ns
tr	Rise time		—	25	—	ns
td(off)	Turn-off delay time		—	150	—	ns
tf	Fall time		—	40	—	ns
VSD	Source-drain voltage	IS = 5A, VGS = 0V	—	1.5	2.0	V
Rth(ch-c)	Thermal resistance	Channel to case	—	—	1.92	°C/W

PERFORMANCE CURVES

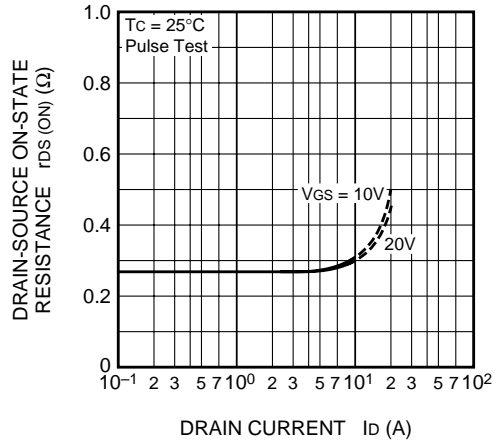


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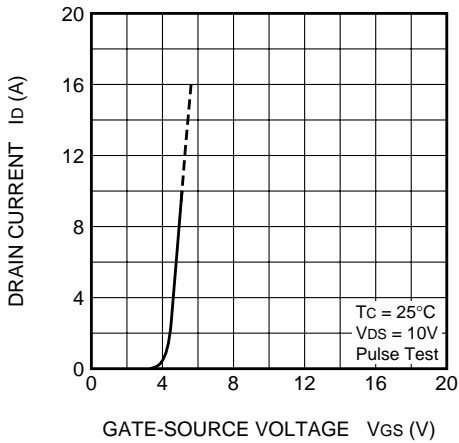
ON-STATE VOLTAGE VS. GATE-SOURCE VOLTAGE (TYPICAL)



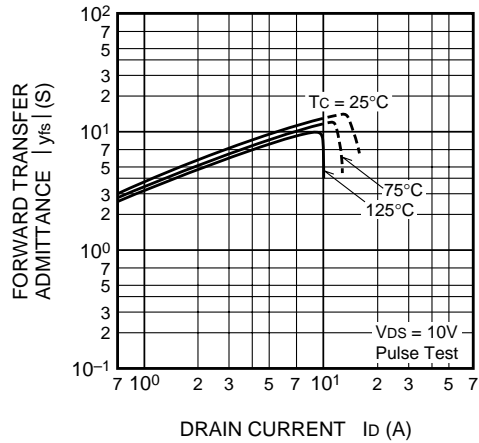
ON-STATE RESISTANCE VS. DRAIN CURRENT (TYPICAL)



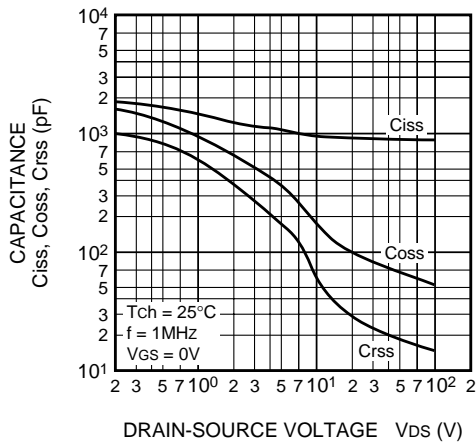
TRANSFER CHARACTERISTICS (TYPICAL)



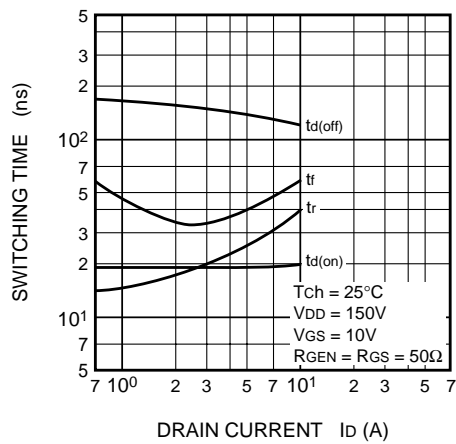
FORWARD TRANSFER ADMITTANCE VS. DRAIN CURRENT (TYPICAL)



CAPACITANCE VS. DRAIN-SOURCE VOLTAGE (TYPICAL)

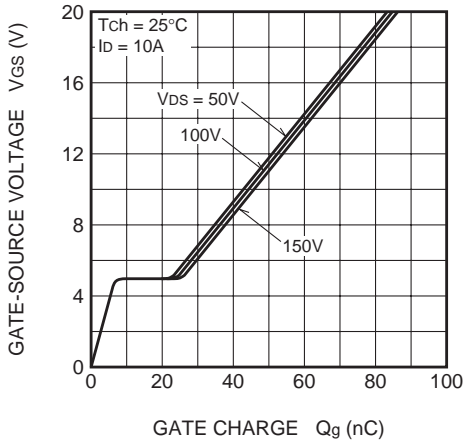


SWITCHING CHARACTERISTICS (TYPICAL)

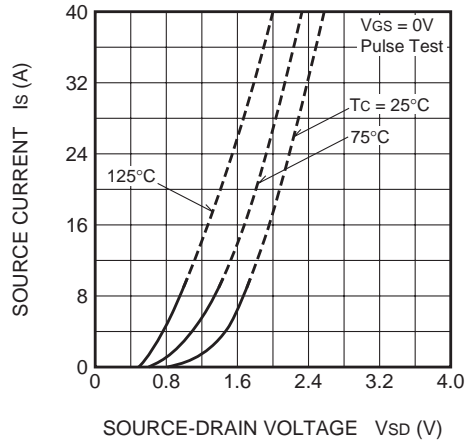


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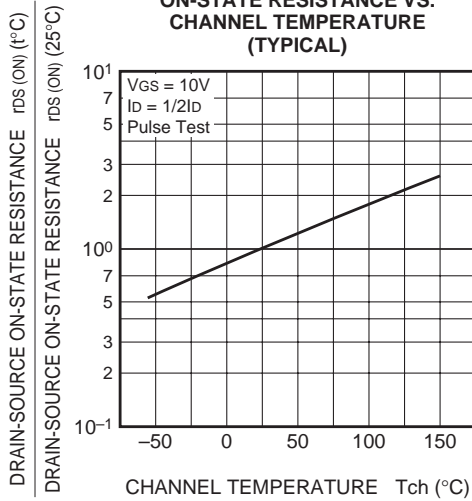
GATE-SOURCE VOLTAGE VS. GATE CHARGE (TYPICAL)



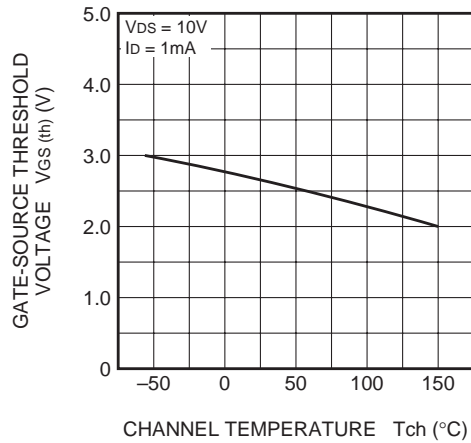
SOURCE-DRAIN DIODE FORWARD CHARACTERISTICS (TYPICAL)



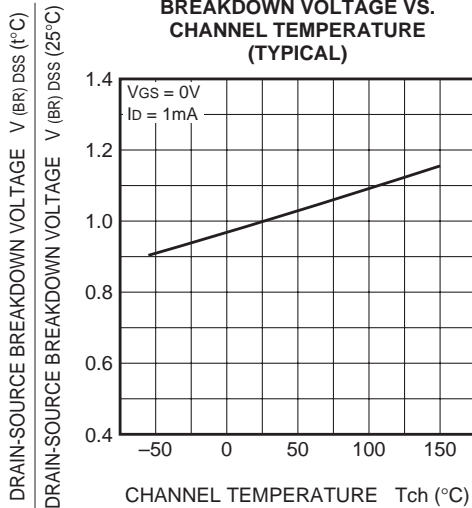
ON-STATE RESISTANCE VS. CHANNEL TEMPERATURE (TYPICAL)



THRESHOLD VOLTAGE VS. CHANNEL TEMPERATURE (TYPICAL)



BREAKDOWN VOLTAGE VS. CHANNEL TEMPERATURE (TYPICAL)



TRANSIENT THERMAL IMPEDANCE CHARACTERISTICS

